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| <b>Notice of References Cited</b> | Application/Control No.<br>09/822,647 | Applicant(s)/Patent Under<br>Reexamination<br>WADA, KAZUSHI |             |
|                                   | Examiner<br>Ida M Soward              | Art Unit<br>2822                                            | Page 1 of 1 |

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